

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: **Chunsuk Suh**

Divisional Appln.  
of Serial No: **09/838,355**

Filed: **Currently herewith**

Docket: **8028-4 DIV**

For: **SEMICONDUCTOR MEMORY DEVICE HAVING METAL CONTACT  
STRUCTURE AND METHOD FOR MANUFACTURING THE SAME**

Mail Stop Patent Application  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Sir:

Before examination of the above-identified application on the merits, kindly enter the present Preliminary Amendment.

**IN THE SPECIFICATION:**

On page 1, after Title, please insert:

**Cross-Reference to Related Application**

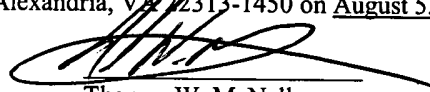
This application is a divisional of U.S. Application Serial No. 09/838,355 filed on April 19, 2001, the disclosure of which in its entirety is incorporated by reference herein.

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**CERTIFICATE OF MAILING 37 C.F.R. § 1.8(a)**

I hereby certify that this correspondence (and any document referred to as being attached or enclosed) is being deposited with the United States Postal Service as first class mail, postage paid in an addressed to: Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on August 5, 2003.

Dated: 05 August 2003

  
Thomas W. McNally